



RDBF251-RDBF2510

2.5A SURFACE MOUNT FAST BRIDGE RECTIFIER

Product Summary (@T_A = +25°C)

V _{RRM} (V)	I ₀ (A)	V _{FM} (V)	Ι _R (μΑ)
1000,800,600, 400,200,100	2.5	1.3	5

Description and Applications

Suitable for AC to DC bridge full wave rectification for SMPS, LED lighting, adapters, battery chargers, home appliances, office equipment, and telecommunication applications.

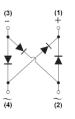
Features and Benefits

- Glass Passivated Die Construction
- Miniature Package Saves Space on PC Boards
- Fast Recovery Time for Higher Efficiency
- Low Leakage Current
- Ideal for SMT Manufacturing
- Low Forward Voltage Drop
- Surge Overload Rating to 75A Peak
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: DBF
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: As Marked on Body
- Weight: 0.02 grams (Approximate)





Internal Schematic

Ordering Information (Note 4)

-			
Part Number	Compliance	Case	Packaging
RDBF2510-13	Commercial	DBF	3,000/Tape & Reel
RDBF258-13	Commercial	DBF	3,000/Tape & Reel
RDBF256-13	Commercial	DBF	3,000/Tape & Reel
RDBF254-13	Commercial	DBF	3,000/Tape & Reel
RDBF252-13	Commercial	DBF	3,000/Tape & Reel
RDBF251-13	Commercial	DBF	3,000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

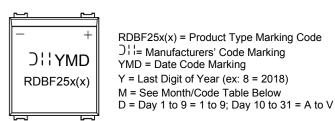
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Notes:



Marking Information



Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D

Maximum Ratings and Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	RDBF251	RDBF252	RDBF254	RDBF256	RDBF258	RDBF2510	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage			100	200	400	600	800	1000	v
RMS Reverse Voltage			70	140	280	420	560	700	V
Average Rectified Output Current (Note 5) @T _C =+110°C			2.5						А
Non-Repetitive Peak Forward Surge Current, Single Half Sine-Wave Superimposed on Rat	I _{FSM}	75						А	
I ² t Rating for Fusing (1ms < t < 8.3ms)	l ² t	23.34					A ² S		
Max Forward Voltage (Per Element) @I _F =2.5A		V _{FM}	1.3						V
Maximum Reverse Recovery Time (Note 7)	t _{RR}		150		250	5	00	ns	
Peak Reverse Current@TA=+25°CAt Rated DC Blocking Voltage (Note 8)@TA=+125°C		I _R		5.0 500				μA	
Total Capacitance (Per Element) (Note 9)					:	30			pF

Thermal Characteristics

Characteristic		Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 6) (Per Element)	R_{\thetaJA}	35	°C/W
Typical Thermal Resistance, Junction to Case (Per Element)	R _{θJC}	7.8	°C/W
Operating and Storage Temperature Range	$T_{J_{J}}T_{STG}$	-55 to +150	°C

Notes:

Device mounted on glass epoxy PC board with 1.3mm² solder pad.
Device mounted on glass epoxy substrate with 1oz/ft², 30mmx30mm copper pad per pin.

7. Measured with $I_F = 0.5A$, $I_R = 1.0A$, $I_{RR} = 0.25A$.

8. Short duration pulse test used to minimize self-heating effect.

9. Measured with V_R = 4.0VDC, f = 1MHz



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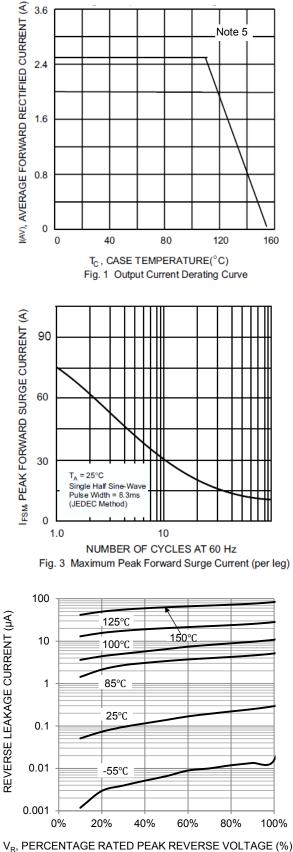
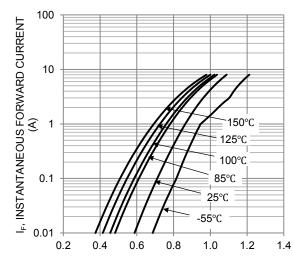
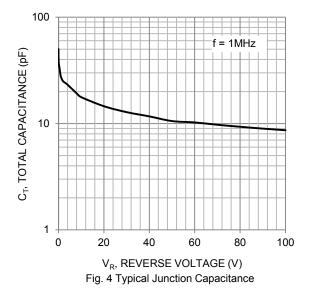


Fig.5 Typical Reverse Characteristics



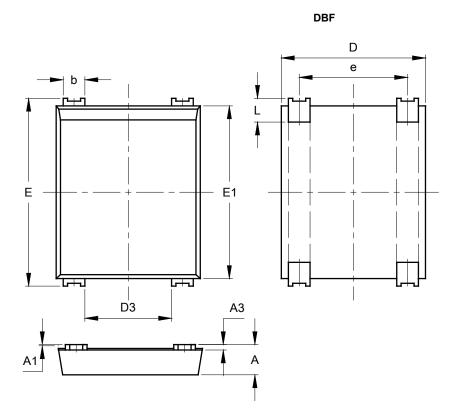
V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics (Per Leg)





Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dim	Min	Max				
Α	1.30	1.50				
A1	0.04	0.12				
A3	0.15	0.35				
b	0.80	1.20				
D	6.45	6.85				
D3	3.80	4.20				
E	8.50	8.90				
E1	7.50	8.20				
е	4.80	5.20				
L	0.50 1.50					
All din	All dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Dimensions	Value (in mm)
С	5.00
C1	7.60
Х	1.40
Y	1.60

DBF



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